# 4 Channel EMI Pi-Filter Array with ESD Protection +4 ESD Diodes

This device is a 4 channel EMI filter array for data lines. Greater than -40~dB attenuation is obtained at frequencies from 800~MHz to 2.2~GHz. It also offers ESD protection – clamping transients from static discharges to protect delicate data line circuitry. It is offered in  $300~\mu m$  and  $350~\mu m$  solder spheres.

#### **Features**

- EMI Filtering and ESD Protection for Data Lines
- Integration of 26 Discretes Offers Cost and Space Savings
- Exceeds IEC61000-4-2 (Level 4) Specifications
- Low Profile Flip-Chip Packaging
- MSL 1
- 300 µm Solder Spheres (NUF4105), Case 499D
- 350 µm Solder Spheres (NUF4115), Case 499F

## **Typical Applications**

- EMI Filtering and ESD Protection for Data Lines
- Cell Phones
- Handheld Portables
- Notebook Computers
- MP3 Players

## **MAXIMUM RATINGS** $(T_A = 25^{\circ}C)$

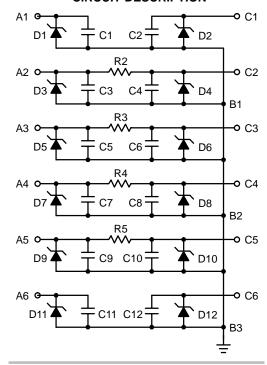
Rating	Symbol	Value	Unit
ESD Discharge IEC61000–4–2,  – Air Discharge  – Contact Discharge  Human Body Model	V <sub>PP</sub>	30 30 16	kV
DC Power per Resistor	P <sub>R</sub>	100	mW
DC Power per Package	P <sub>T</sub>	400	mW
Junction Temperature	TJ	150	°C
Operating Temperature Range	T <sub>op</sub>	-40 to +85	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C



## ON Semiconductor®

http://onsemi.com

#### CIRCUIT DESCRIPTION



FLIP-CHIP CASE 499D 300 µm Bumps FLIP-CHIP CASE 499F 350 µm Bumps





## **DEVICE MARKING**

NUF41xxYYWW

xx = 05 or 15YY = Year

WW = Work Week

## **ORDERING INFORMATION**

Device	Package	Shipping
NUF4105FCT1	Flip-Chip	3000/Tape & Reel
NUF4115FCT1	Flip-Chip	3000/Tape & Reel

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Characteristic	Min	Тур	Max	Unit
$V_{BR}$	$I_Z = 10 \text{ mA}$	6.0	7.0	8.0	V
I <sub>R</sub>	V <sub>RM</sub> = 3.3 V per line	-	-	0.1	μΑ
R <sub>I/O</sub>	$I_R = 20 \text{ mA}$	80	100	120	Ω
C <sub>line</sub>	$V_{R=} 2.5 \text{ V}, f = 1.0 \text{ MHz (Note 1)}$	-	53	-	pF

<sup>1.</sup> Measured from input/output pins to ground.

## **TYPICAL PERFORMANCE CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise specified})$ 

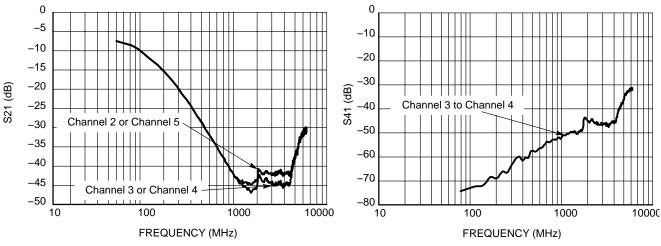


Figure 1. Insertion Loss Curve (S21 Measurement)

Figure 2. Analog Crosstalk Curve (S41 Measurement)

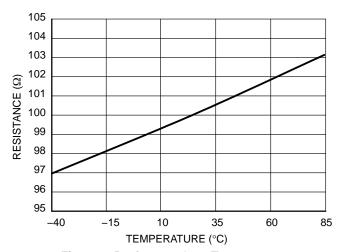


Figure 3. Resistance Over Temperature

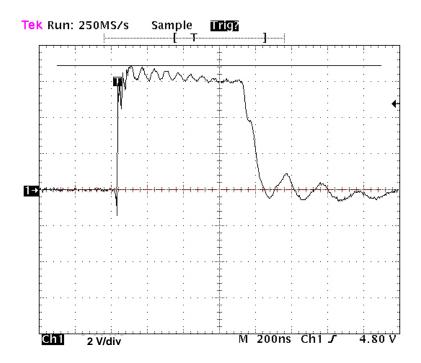


Figure 4. ESD Response for Human Body Model (+8.0 kV)

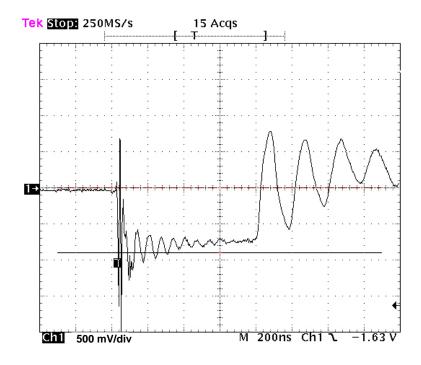


Figure 5. ESD Response for Human Body Model (-8.0 kV)

## **Printed Circuit Board Recommendations**

Parameter	500 μm Pitch 300 or 350 μm Solder Ball
PCB Pad Size	250 μm +25 –0
Pad Shape	Round
Pad Type	NSMD
Solder Mask Opening	350 μm ±25
Solder Stencil Thickness	125 μm
Stencil Aperture	250 x 250 μm sq.
Solder Flux Ratio	50/50
Solder Paste Type	No Clean Type 3 or Finer
Trace Finish	OSP Cu
Trace Width	150 μm Max

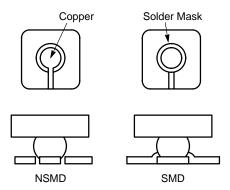


Figure 6. Solder Mask versus Non-Solder Mask Definition

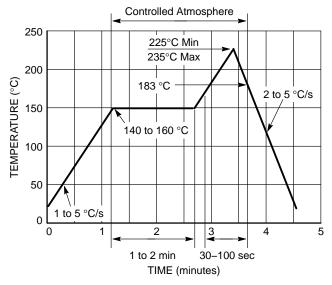
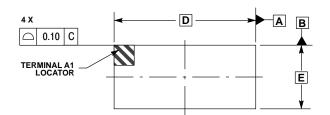


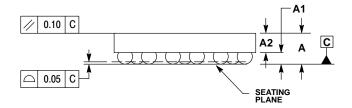
Figure 7. Solder Reflow Profile

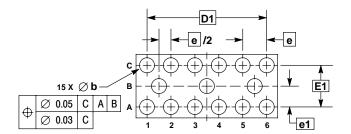
## **PACKAGE DIMENSIONS**

## 15 PIN FLIP-CHIP CSP CASE 499D-01

ISSUE O







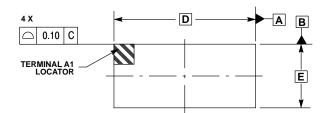
- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

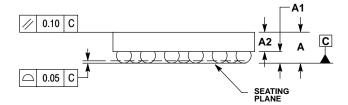
	MILLIMETERS		
DIM	MIN	MAX	
Α		0.700	
A1	0.210	0.270	
A2	0.380	0.430	
D	2.960 BSC		
Е	1.330 BSC		
b	0.290	0.340	
е	0.500 BSC		
e1	0.435 BSC		
D1	2.500 BSC		
F1	0.870 BSC		

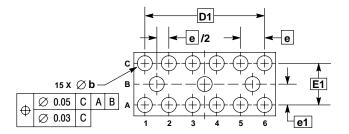
## PACKAGE DIMENSIONS

## 15 PIN FLIP-CHIP CSP CASE 499F

**ISSUE PRELIMINARY** 







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